## VIINIATURE GRYSTAL

**CX-3-SM** 800kHz to 1.35MHz LOW-PROFILE MINIATURE SMD GRYSTAL

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- Extensional mode
- Ideal for use with microprocessors
- Designed for low power applications
- Compatible with hybrid or PCB mounting
- Low ageing
- Full military environmental testing available
- Ideal for battery operated applications

### **Specification**

±0.05% (±500ppm)

800kHz to 1.35MHz

±0.1%

±1.0%

Extensional

Α: **B**:

C:

7pF

1.2fF

150k

1.0pF  $3\mu W$  max.

35°C

fo ±5ppm max.

-0.035ppm/°C<sup>2</sup>

 $\frac{f-fo}{f} = k(T-To)^2$ 

-55°C~+125°C 260°C for 20 seconds

1,000g peak, 0.3ms, 1/2 sine

-40°~+85°C (industrial) -55°~+125°C (military)

10g rms 20-1,000Hz random -10°~+70°C (commercial)

 $5k\Omega$  max.

**Frequency Range: Functional Mode: Calibration Tolerance\*:** 

Load Capacitance: Motional Resistance (R<sub>1</sub>): Motional Capacitance (C<sub>1</sub>): Quality Factor (Q): Shunt Capacitance (C<sub>0</sub>): **Drive Level:** Turning Point (T<sub>0</sub>)\*\*: **Temperature Coefficient (k):** Note: Frequency (f) deviation from frequency (f0) @ turning point

temperature (t0) =

Ageing, first year: Shock: Vibration, survival: **Operating Temperature:** 

**Storage Temperature: Max. Process Temperature:** 

Specifications are typical at 25°C unless otherwise indicated.

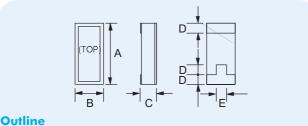
- Closer frequency calibration available
- Other turning point available

### **Terminations**

Designation	Termination
SM1	Gold Plated
SM2	Nickel, Silver Plated
SM3	Nickel, Solder Plated and Solder Dipped

**General Description** 

CX-3-SM quartz crystals are leadless devices designed for surfacemounting on printed circuit boards or hybrid circuits. Hermetically sealed in a rugged, ceramic package, the crystals are produced utilizing a photo-lithographic process giving excellent repeatability and consistent high quality.

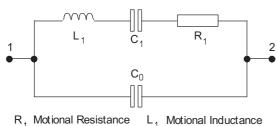


#### **CX-3-SM Package Dimensions**

Dimension	Typical (mm)	Maximum (mm)
А	6.73	7.11
В	2.62	2.90
С	-	see below
D	1.27	1.52
E	1.32	1.57

Dimension "C"	Glass Lid (mm max.)	Ceramic Lid (mm max.)
SM1	1.47	1.75
SM2	1.52	1.80
SM3	1.60	1.88

#### **Equivalent Circuit**



C1 Motional Capacitance C0 Shunt Capacitance

### VIINIATURE CRYSTAL

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### **Circuit Design**

#### **Typical Pierce Oscillator Application**

The low profile CX miniature surface-mount crystal is ideal for small, battery operated portable products. The CX crystal designed in a Pierce oscillator (single inverter) circuit has a very low current consumption with high stability. A conventional HCMOS Pierce oscillator circuit is shown below. The crystal is effectively inductive and in a Pi network with  $C_1$  and  $C_2$  which provides the additional phase-shift necessary to sustain oscillation. The oscillation frequency  $(f_0)$  is 15ppm to 150ppm above the crystal's series resonant frequency (F<sub>s</sub>).

#### **Drive Level**

 $R_{A}$  is used to limit the crystal's drive level by forming a voltage divider between  $R_{\!_{A}}$  and  $C_{\!_{1}}.$   $R_{\!_{A}}$  also stabilizes the oscillator against changes in the amplifiers output resistance (R<sub>0</sub>). R<sub>A</sub> should be increased for higher voltage operation.

#### **Load Capacitance**

The CX crystal calibration tolerance is influenced by the effective circuit capacitances, specified as the load capacitance ( $C_1$ .)  $C_1$  is

$$C_{L} = \frac{C_1 \times C_2}{C_1 + C_2} + C_{S}$$

NOTE: C1 and C2 include stray layout capacitance to ground. Cs is the stray shunt capacitance between the crystal terminals. In practice, the effective valus of C<sub>1</sub> will be less than that calculated from C1, C2, and CS values due to the effect of the amplifier output resistance. C<sub>s</sub> should be minimized.

The oscillation frequency  $(f_n)$  is approximately equal to:

$$f_0 = f_S \left[ 1 + \frac{C_1}{2(C_0 + C_L)} \right]$$

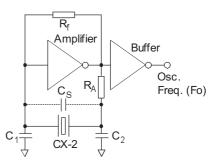
Where  $F_s$  = Series resonant frequency of the crystal

C<sub>1</sub> = Motional Capacitance

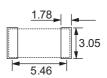
C<sub>0</sub> = Shunt Capacitance

**Order Code** 





#### Solder Pad Layout



### Packaging

CX-3H-SM- Bulk Pack (Standard)

- 16mm tape, 178mm or 330mm reels (Optional) per EIA 481
  - Tray Pack (Optional)

